
A Class F^{-1}/F 24-to-31GHz Power Amplifier with 40.7% Peak PAE, 15dBm OP_{1dB} , and 50mW P_{sat} in 0.13 μ m SiGe BiCMOS

Seyed Yahya Mortazavi

Kwang-Jin Koh

Multifunctional Integrated Circuits & Systems Group

Virginia Tech, Blacksburg, VA



Outline

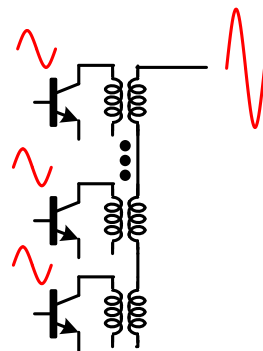
- Background / Motivation
 - Challenge in Silicon mm-Wave PAs
 - Efficiency of mm-Wave PAs
 - Harmonic Tuned (Class-F⁻¹, Class-F) PAs
- Class-F⁻¹ to Class-F Mode-Transition PA Design
- Measurement Results
- Conclusion

Challenge in Silicon mm-Wave PAs

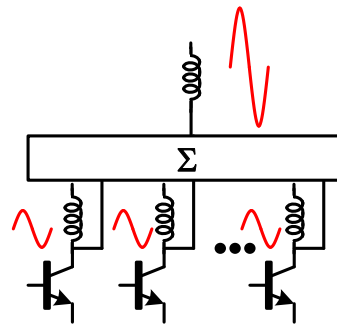
- Speed-breakdown tradeoff
- Not sufficient silicon transistor speed (f_T , f_{max}) for mm-wave

⇒ Small P_{out} per PA stage

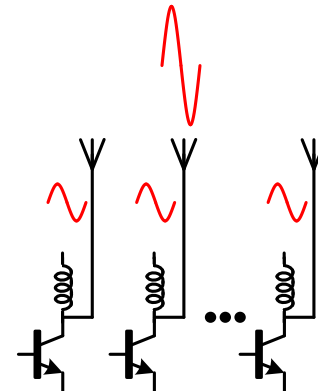
- Power combining with a PA-array can increase P_{out} .



Series combining
(e.g. distributed transformer)



Parallel combining
(e.g. Wilkinson)

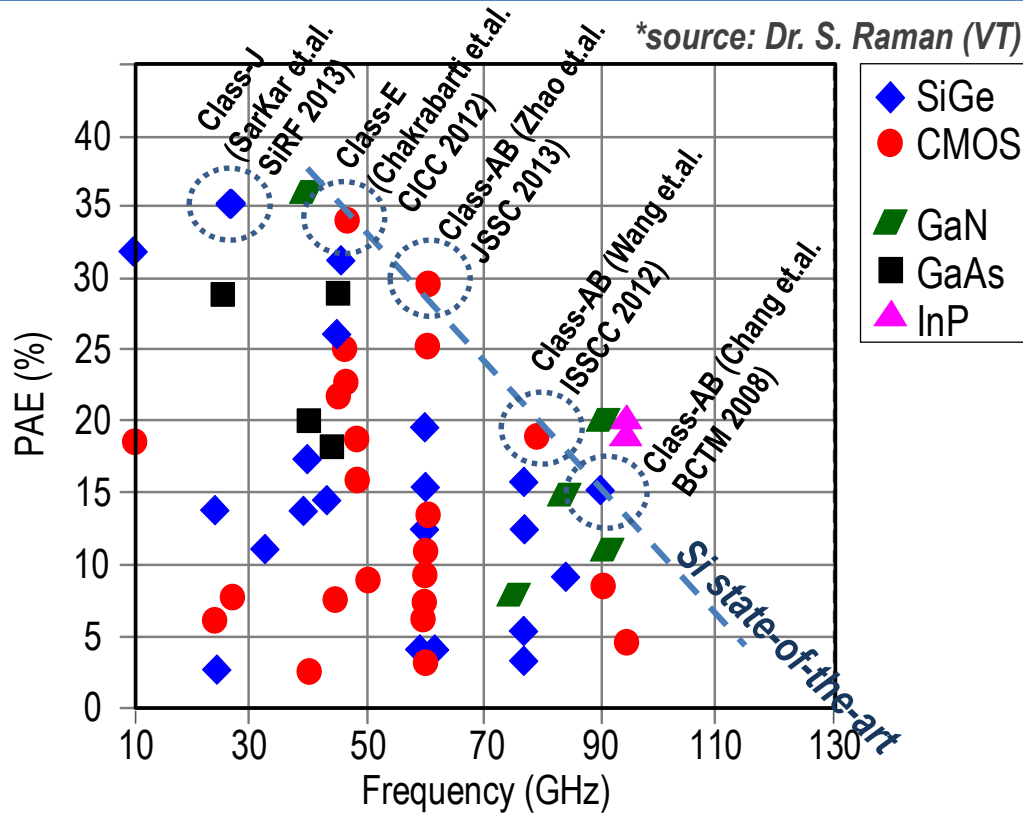


Spatial combining
(e.g. phased array)

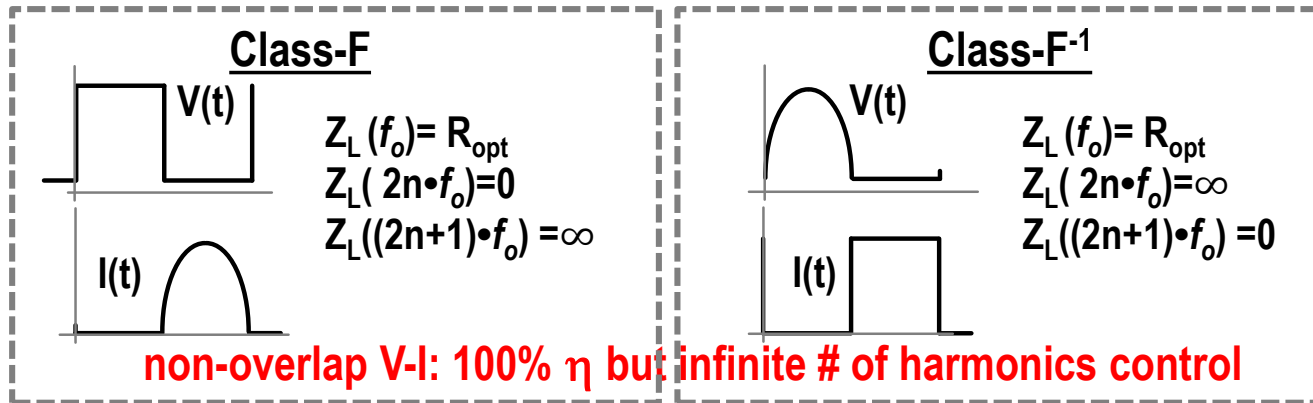
⇒ Low power-added efficiency (PAE)

- It is critical to improve unit PA's PAE to improve overall PAE in a PA-array.
- Relatively, a lack of research on efficient PA topology suitable for mm-wave.

Efficiency of mm-Wave PAs

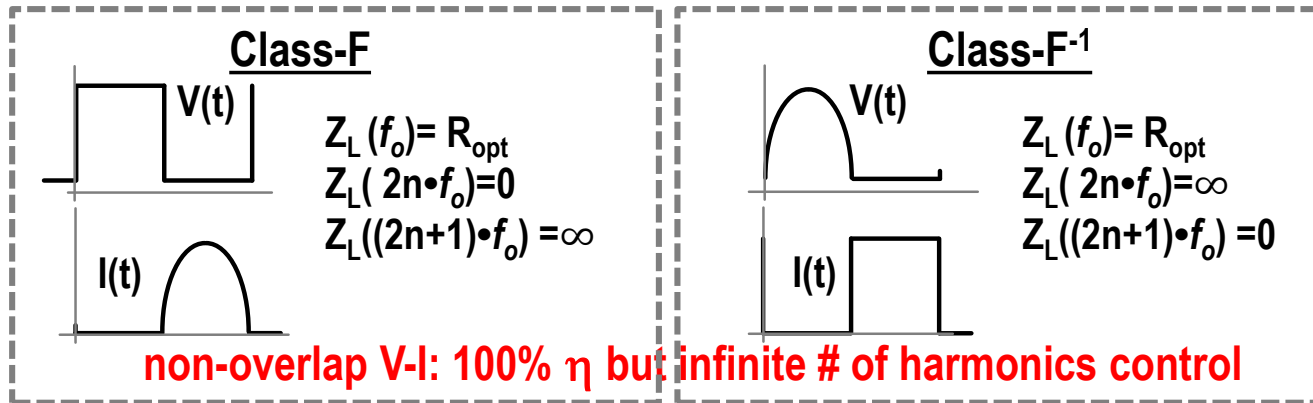


Harmonic Tuned (Class-F, Class-F⁻¹) PAs



- In practice, ~ up to the 3rd harmonic power control at mm-wave with a finite V_{knee} (e.g. practical max. $\eta \sim 90\% \times (V_{CC} - V_{knee}) / V_{CC} = 68\%$ if $V_{CC} = 2V$ & $V_{knee} = 0.5V$).

Harmonic Tuned (Class-F, Class-F⁻¹) PAs

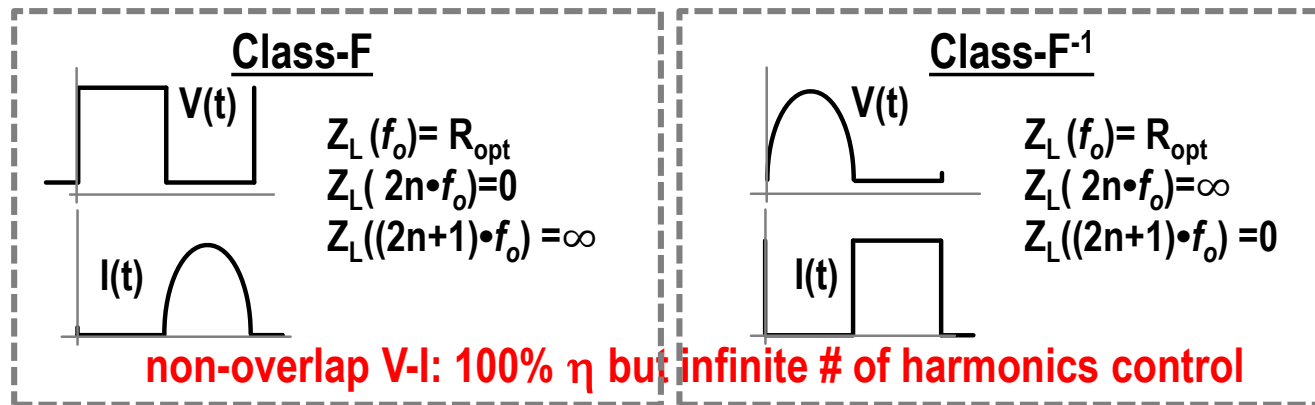


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Pros:

- Current-mode: power transistor operates as a current source
- Class-AB biasing: fast speed, high gain
- No switching loss involved
- On-chip high-Q L-C networks are readily available for harmonic-Z control @mm-wave

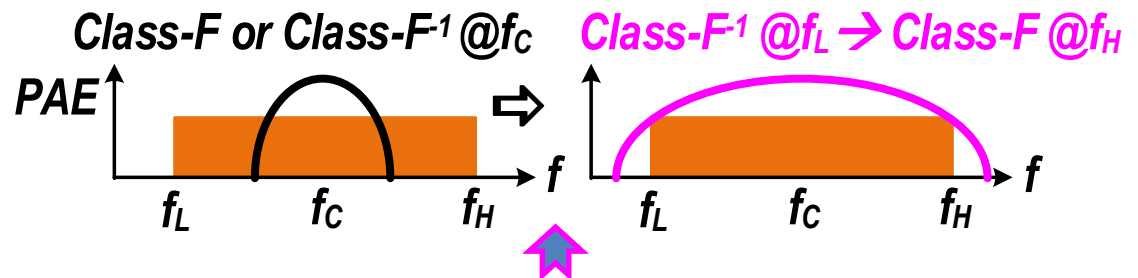
Harmonic Tuned (Class-F, Class-F⁻¹) PAs



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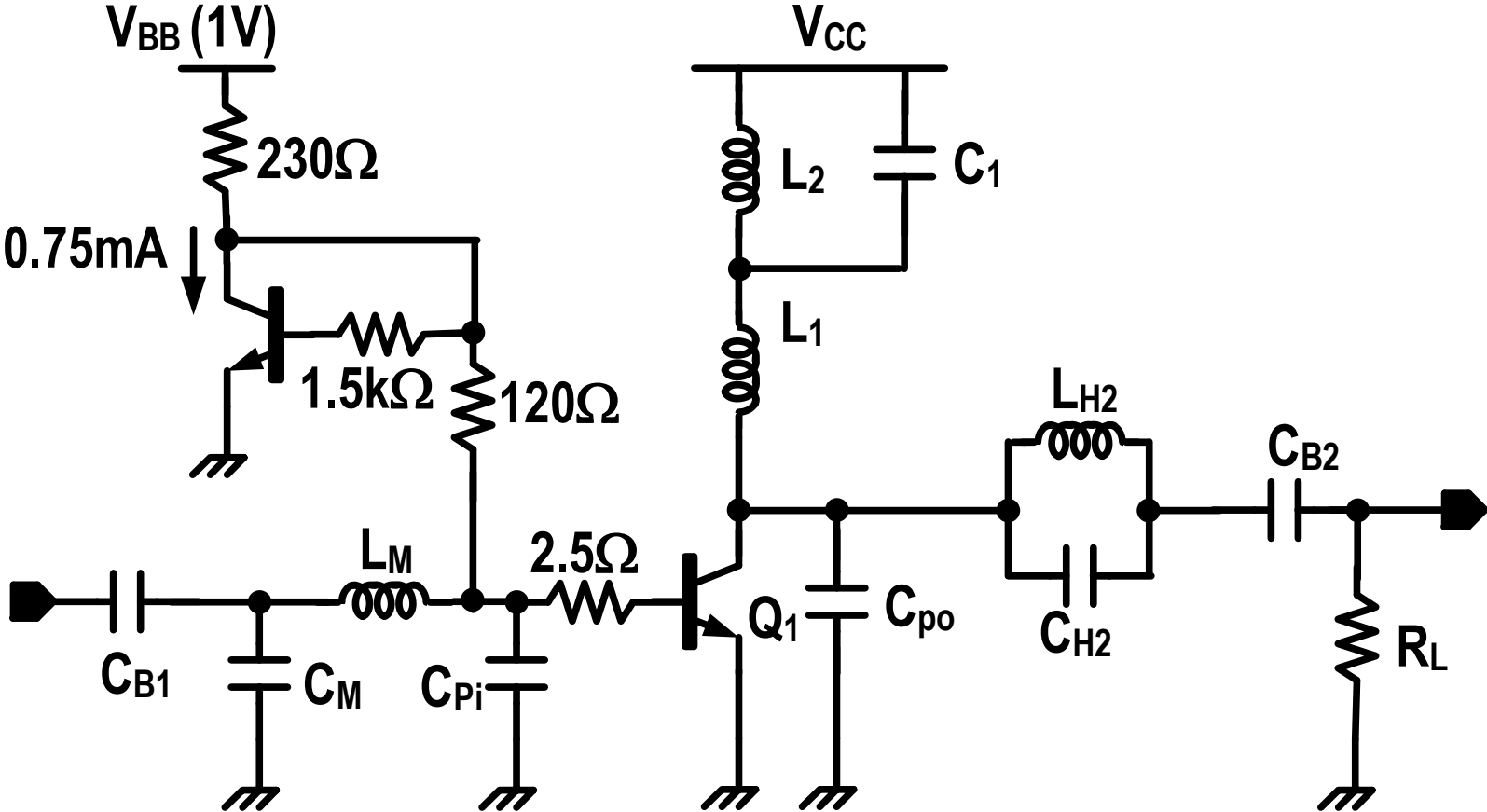


Cons:

- Narrowband PAE

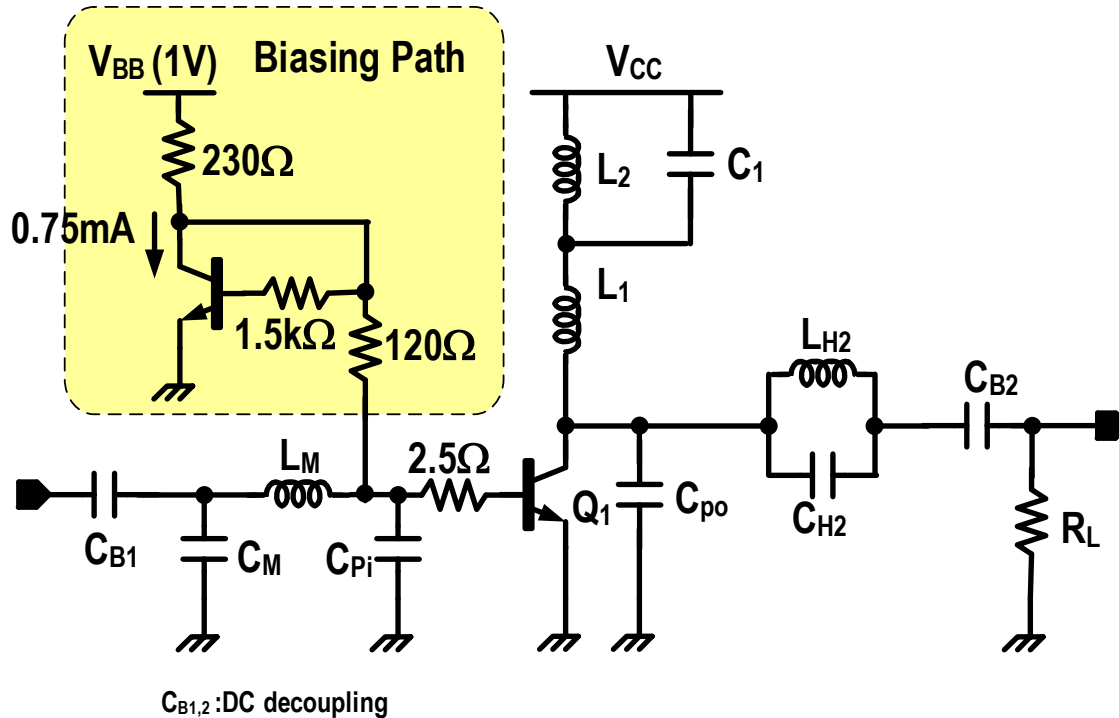
⇒ Need a wideband technique: motivation of “mode-transition” operation.

Proposed Class-F⁻¹ to Class-F Mode-Transition PA



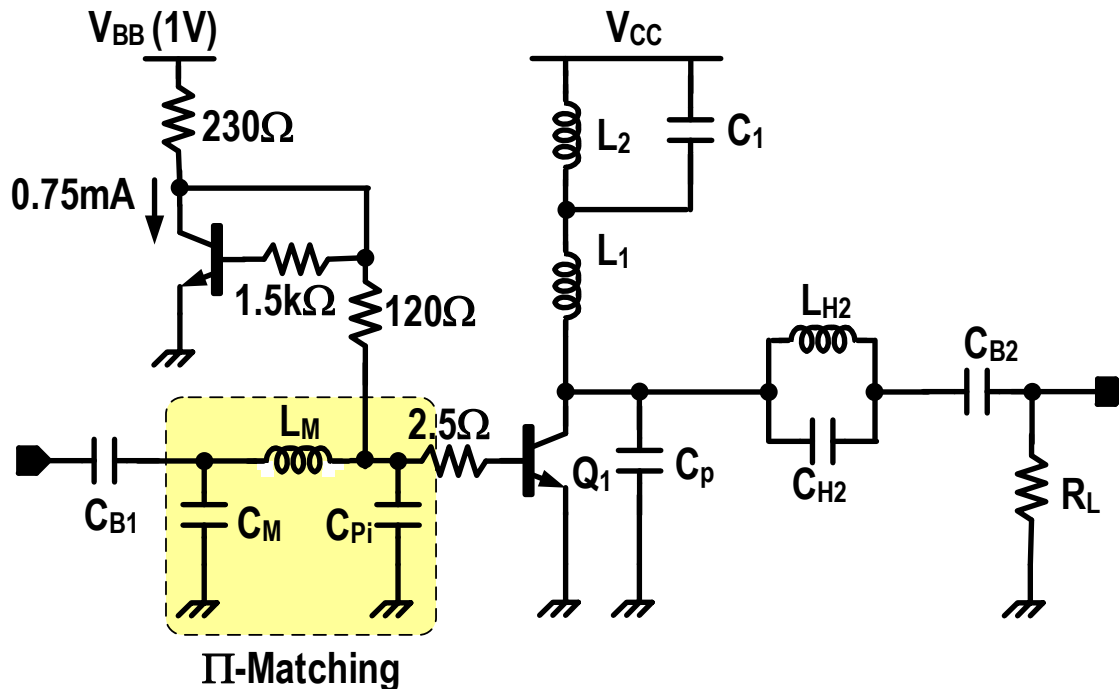
$C_{B1,2}$:DC decoupling

Class-F⁻¹ to Class-F Mode-Transition PA (1)



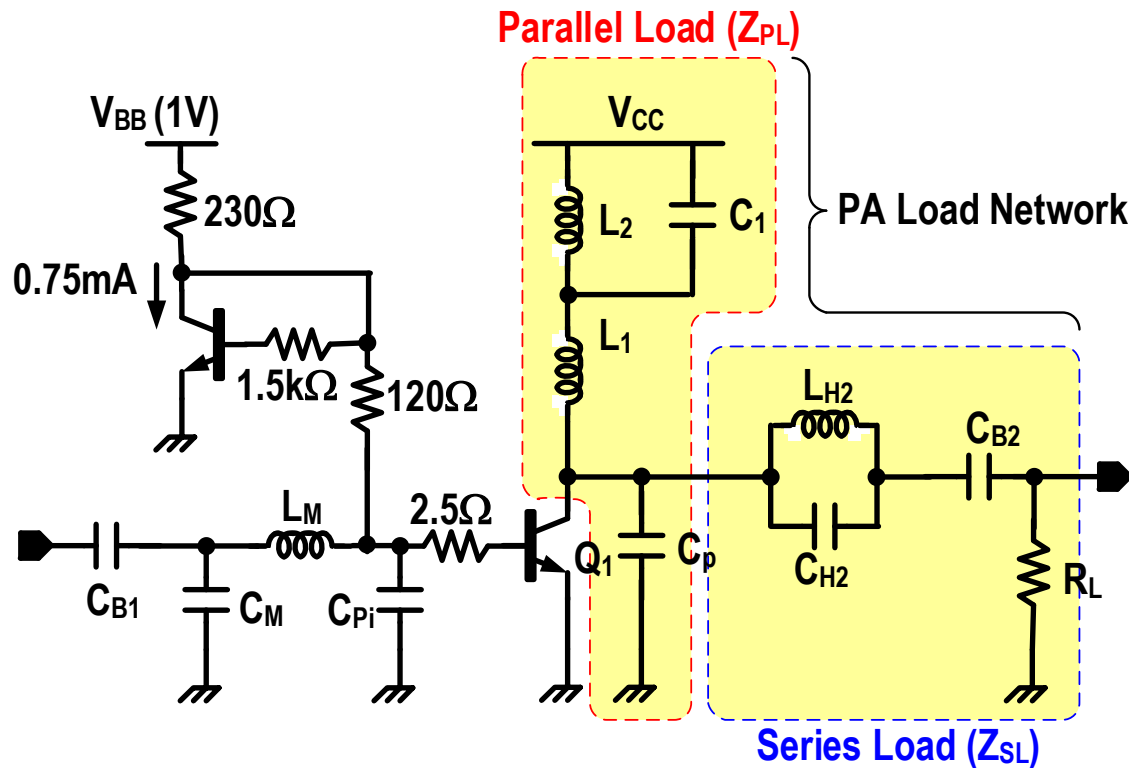
- Class-AB biasing: $V_{BE} = 0.85 \text{ V}$ & $I_{CE} = 9 \text{ mA}$ ($V_{CC} = 2.2 \text{ V}$, $V_{knee} = 0.5 \text{ V}$)
- Sizing for peak f_T ($\sim 180 \text{ GHz}$) @ $P_{sat} = 50 \text{ mW}$
- Impedance seen from base is $< 300\text{-}\Omega$ so that $V_{CE, peak} \sim 3 \times BV_{CEO} \sim 5 \text{ V}$ @ Class-F⁻¹ ($BV_{CEO} \sim 1.7 \text{ V}$ & $BV_{CBO} \sim 5.5 \text{ V}$)

Class-F⁻¹ to Class-F Mode-Transition PA (2)



- Π-matching network provides a wideband Z-matching:
 $S_{11} < -10$ dB @23-31 GHz (sim.).
- C_{pi} includes base-node parasitic capacitances including layout parasitics.
- 2.5 Ω base resistance stabilizes the PA over all operation frequencies.

Class-F⁻¹ to Class-F Mode-Transition PA (3)

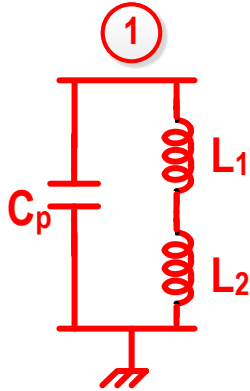


- Z_{PL} & Z_{SL} comprise multi-resonance harmonic tuned load, cooperatively shaping an optimum load impedance for Class-F⁻¹ and Class-F operations.
- C_p includes collector-node parasitic capacitances including layout parasitics.
- *L_2 - C_1 tank impedance variation over harmonic frequencies plays a key role in transferring from Class-F⁻¹ to Class-F over 24-31 GHz (see next slides).*

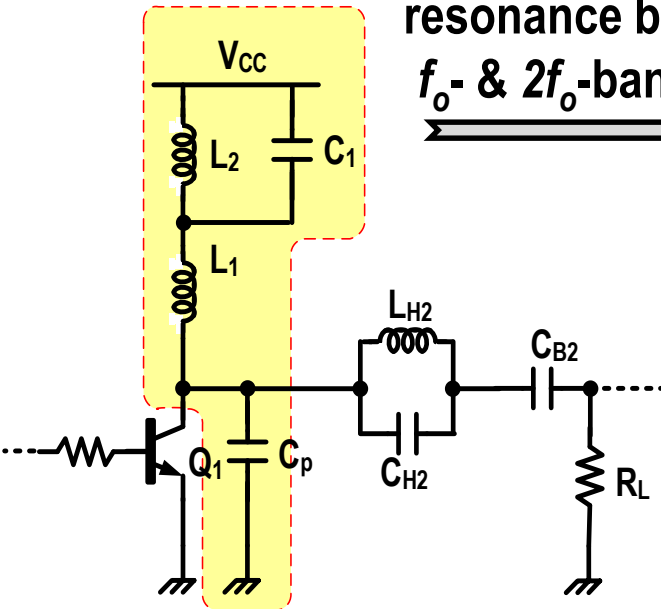
Load Network with F^{-1}/F Mode Transition (1)

Parallel Load (Z_{PL})

resonance btw
 f_o - & $2f_o$ -band

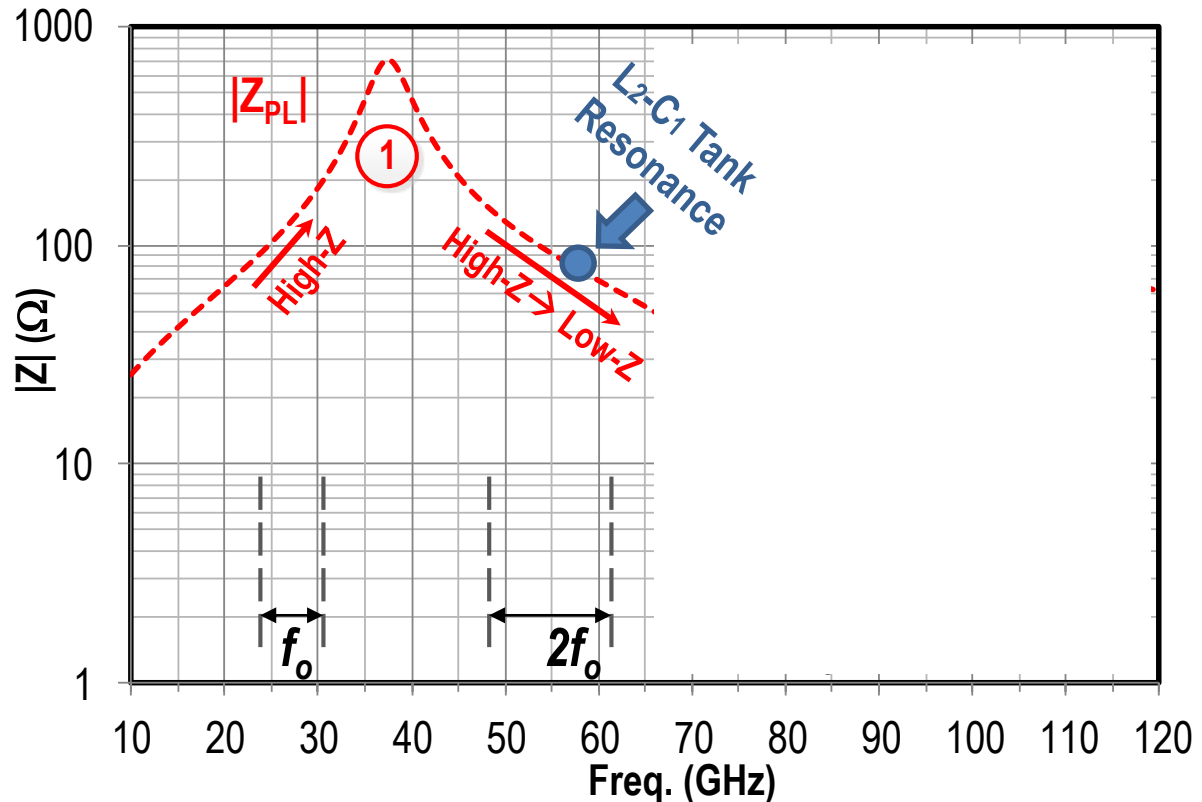


This tank provides relatively high impedance for both fundamental (f_o) and the 2nd harmonic ($2f_o$) bands.



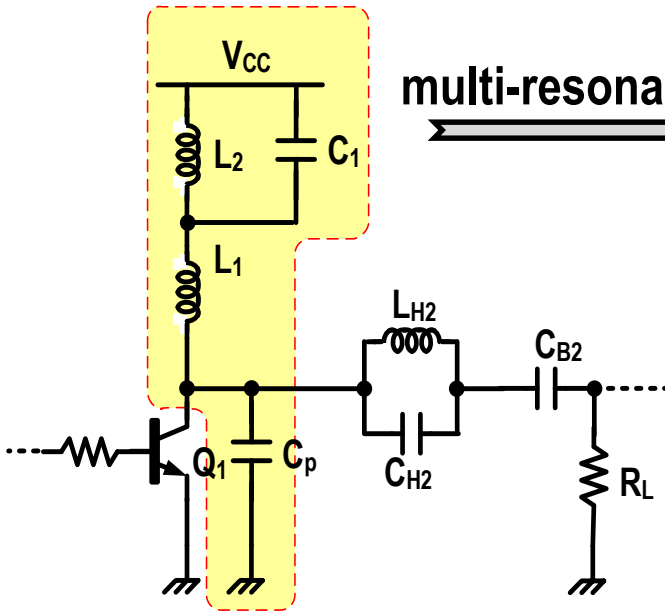
Z_{PL} Modulation by L_2 - C_1 Tank

①: $L_2 \parallel C_1 \sim L_2$
 $\rightarrow Z_{PL} = s(L_1 + L_2) \parallel 1/sC_p$

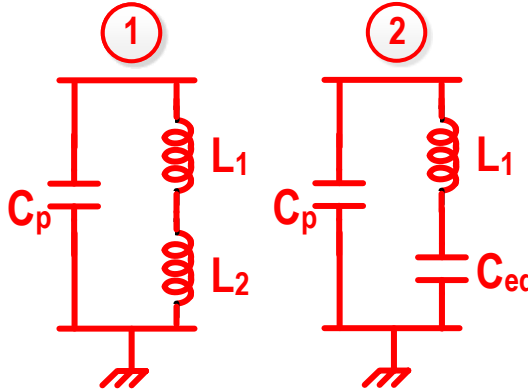


Load Network with F^{-1}/F Mode Transition (2)

Parallel Load (Z_{PL})



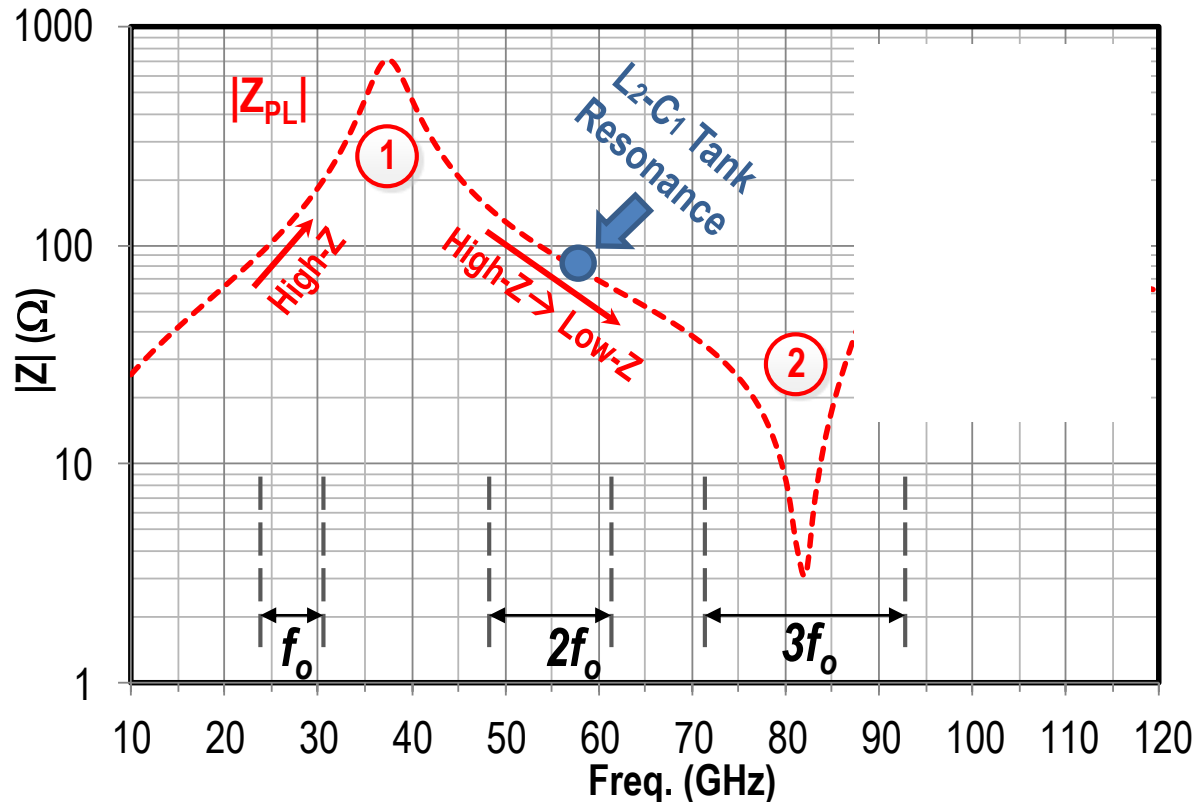
multi-resonance



L_1 - C_{eq} series resonance forms a sharp impedance null in the middle of the 3rd harmonic ($3f_o$) band.

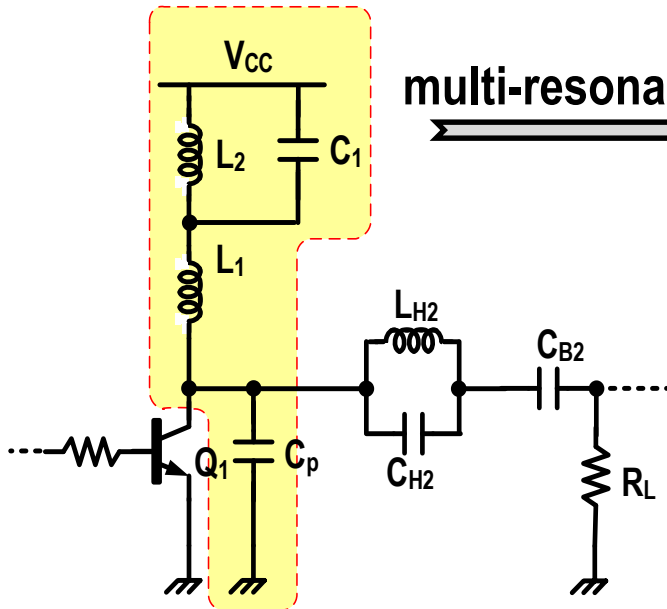
Z_{PL} Modulation by L_2 - C_1 Tank

- ①: $L_2 \parallel C_1 \sim L_2$
 $\rightarrow Z_{PL} = s(L_1 + L_2) \parallel 1/sC_p$
- ②: $L_2 \parallel C_1 \sim C_{eq}$
 $\rightarrow Z_{PL} = sL_1 + 1/sC_{eq}$

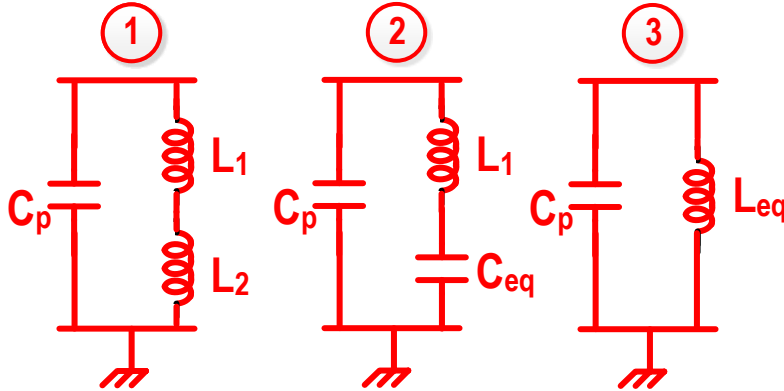


Load Network with F^{-1}/F Mode Transition (3)

Parallel Load (Z_{PL})



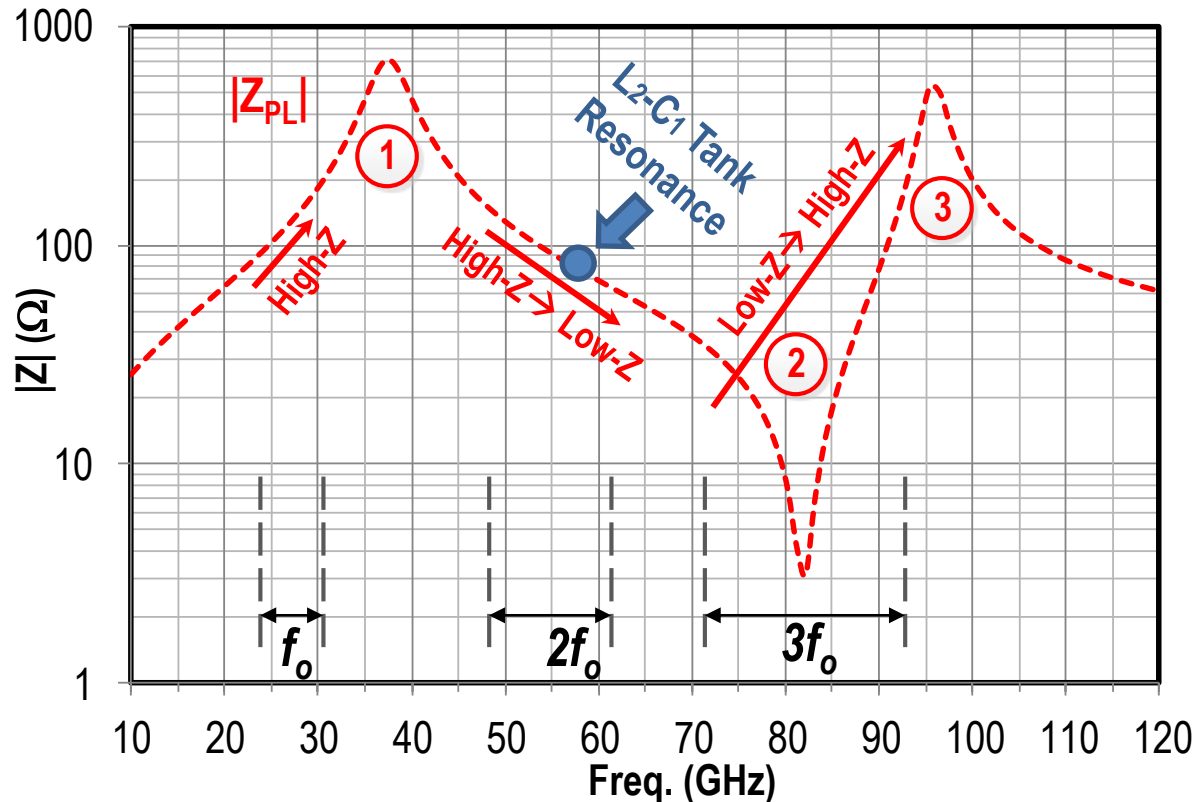
multi-resonance



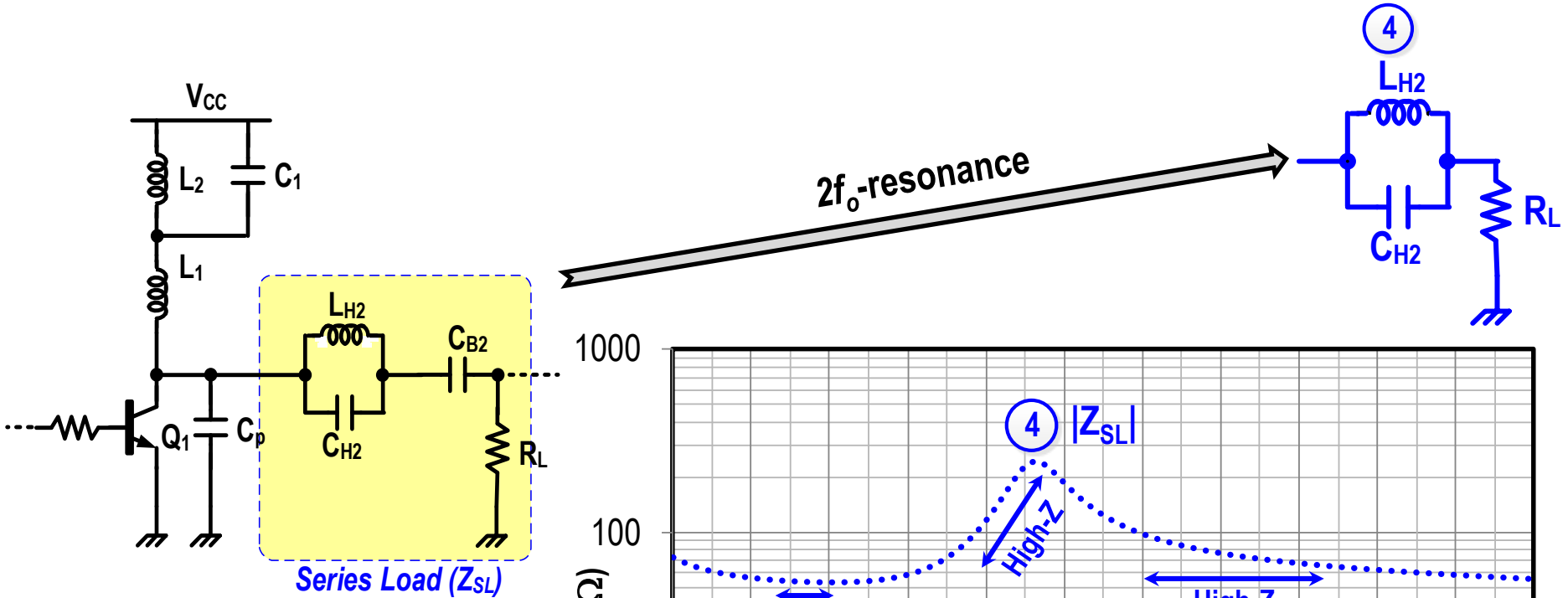
L_{eq} - C_p parallel resonance forms an impedance maxima at the edge of the $3f_o$ -band.

Z_{PL} Modulation by L_2 - C_1 Tank

- ①: $L_2 \parallel C_1 \sim L_2$
 $\rightarrow Z_{PL} = s(L_1 + L_2) \parallel 1/sC_p$
- ②: $L_2 \parallel C_1 \sim C_{eq}$
 $\rightarrow Z_{PL} = sL_1 + 1/sC_{eq}$
- ③: $L_1 - C_1 \sim L_{eq}$
 $\rightarrow Z_{PL} = sL_{eq} \parallel 1/sC_p$

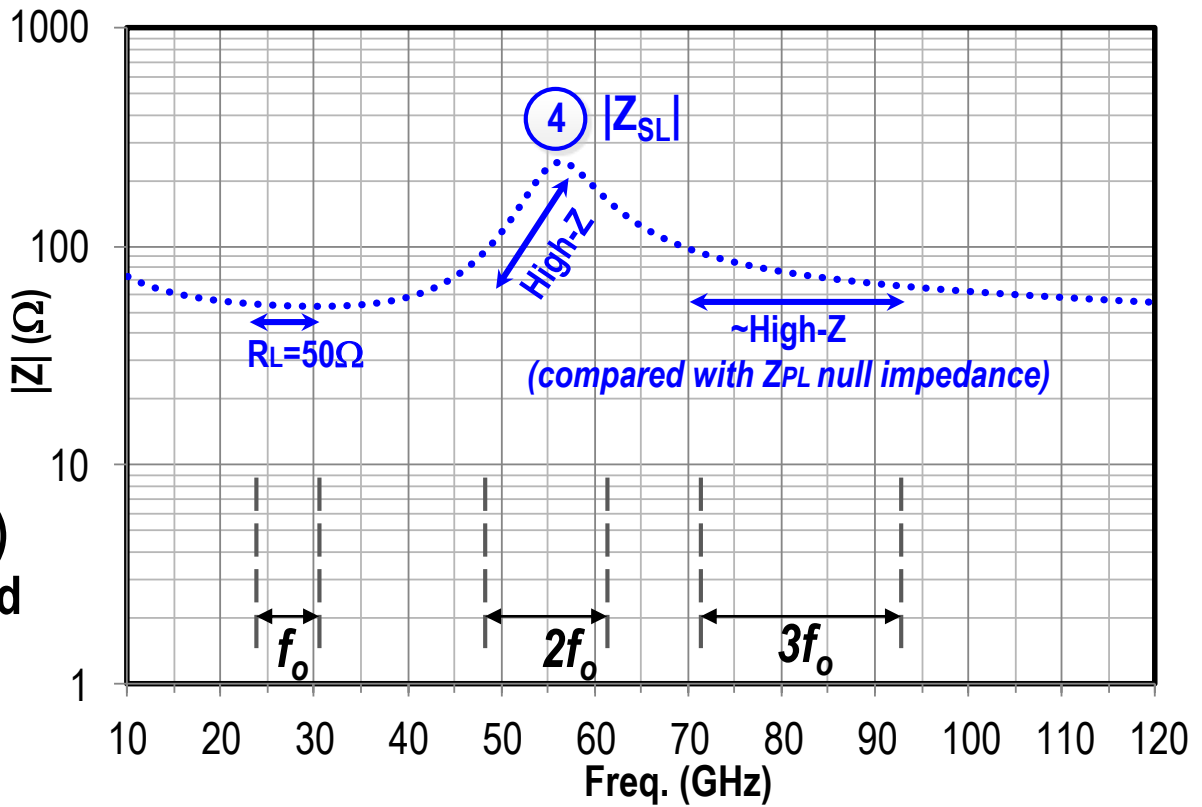


Load Network with F^{-1}/F Mode Transition (4)



Z_{SL} Modulation by L_{H2}-C_{H2} Tank

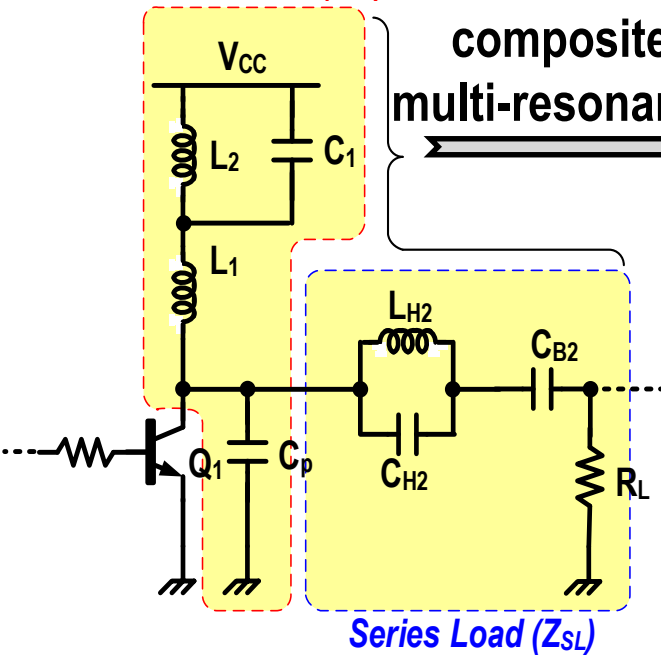
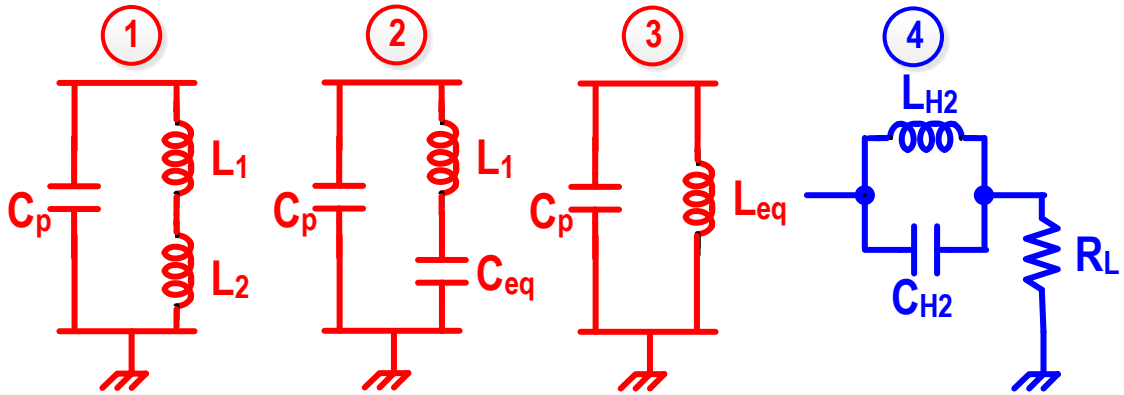
- f₀-band: ~ constant 50 Ω
- 2f₀-band: High-Z (resonance)
- 3f₀-band: ~ High-Z (compared with Z_PL null impedance)



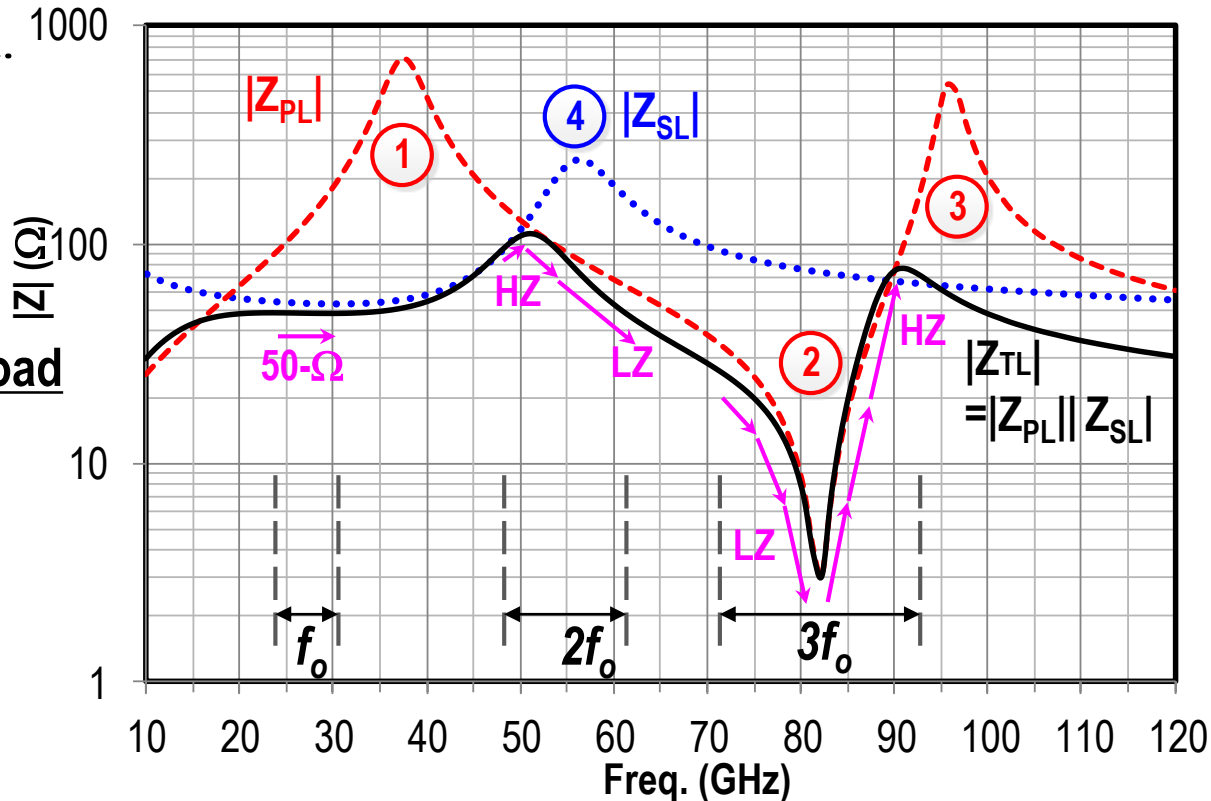
Load Network with F^{-1}/F Mode Transition (5)

Parallel Load (Z_{PL})

composite
multi-resonance



Series Load (Z_{SL})

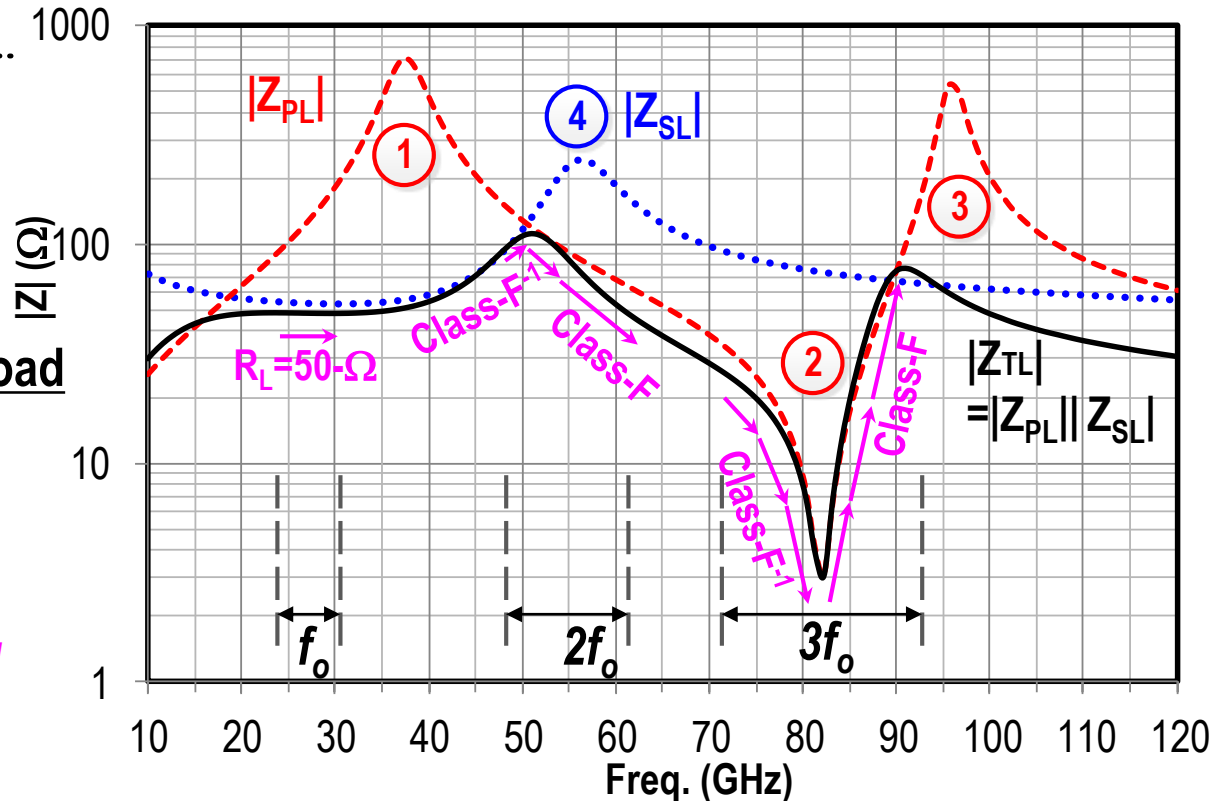
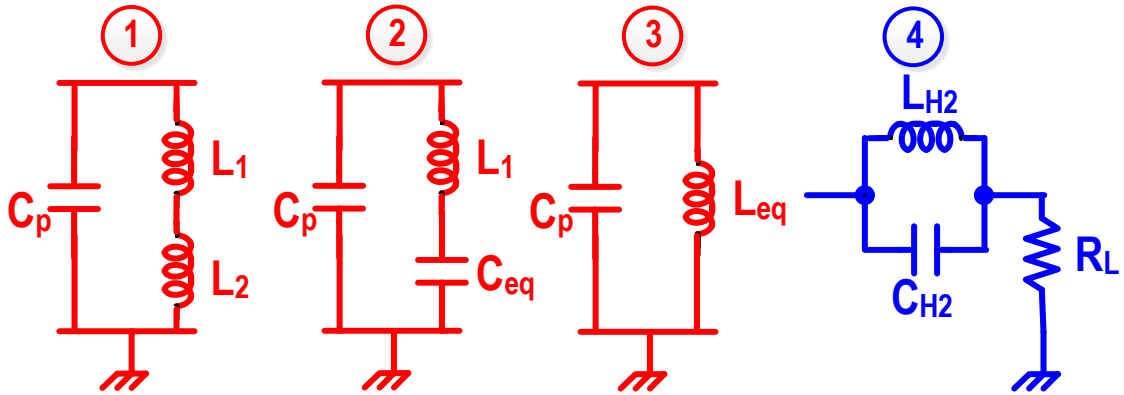
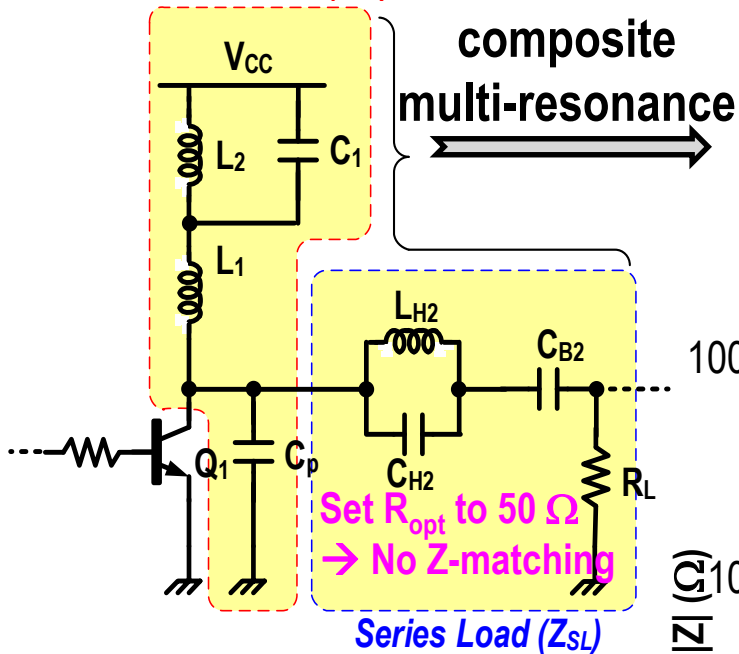


$|Z_{TL}|$ Modulation by composite load

- f_o -band: $50 \Omega \rightarrow 50 \Omega$
- $2f_o$ -band: High-Z \rightarrow Low-Z
- $3f_o$ -band: Low-Z \rightarrow High-Z

Load Network with F^{-1}/F Mode Transition (6)

Parallel Load (Z_{PL})



$|Z_{TL}|$ Modulation by composite load

- f_0 -band: $50 \Omega \rightarrow 50 \Omega$
 - $2f_0$ -band: High-Z \rightarrow Low-Z
 - $3f_0$ -band: Low-Z \rightarrow High-Z
- Class-F $^{-1}$ \rightarrow Class-F

@ low f_0 -band @ high f_0 -band



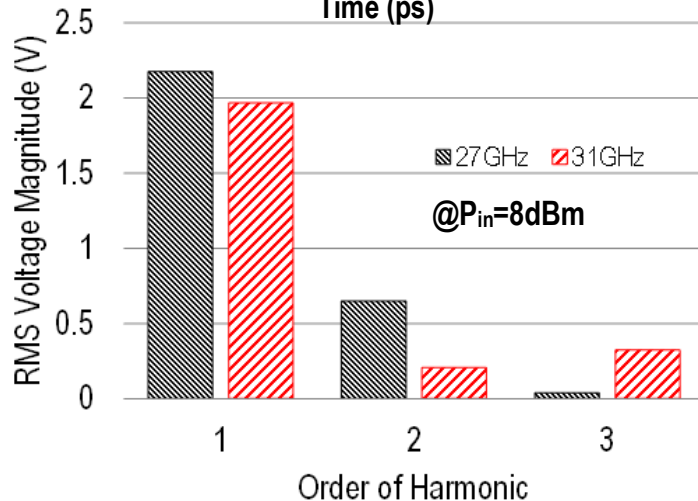
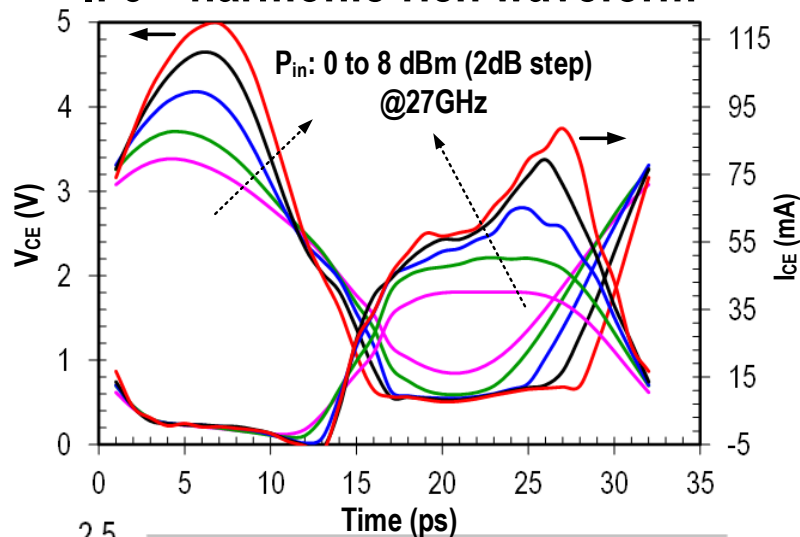
14.4: A Class-F $^{-1}/F$ 24-to-31 GHz Power Amplifier with 40.7% Peak PAE, 15dBm OP_{1dB} , and 50mW P_{sat} in 0.13 μ m SiGe BiCMOS

Simulated Collector V-I Waveforms (1)

Class-F⁻¹ @27-GHz, P_{in}=8-dBm

V: Half-sinusoidal peaking

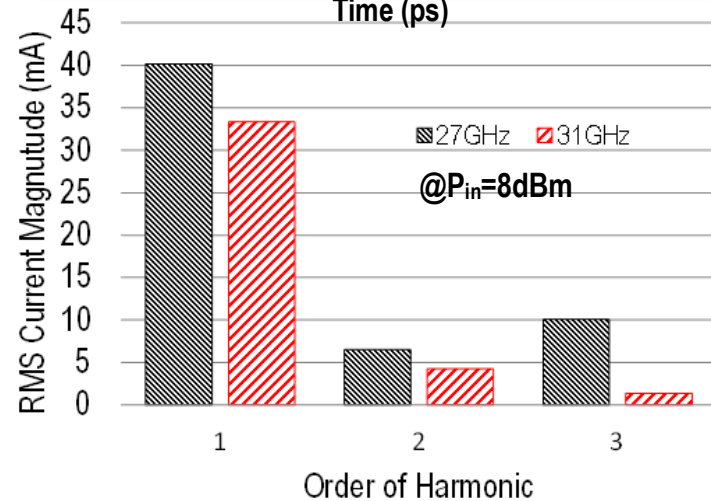
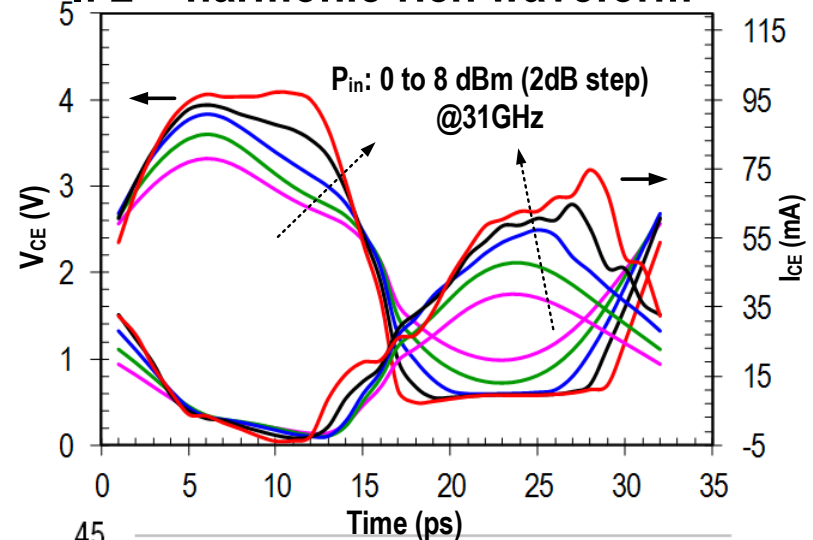
I: 3rd-harmonic-rich waveform



Class-F @31-GHz, P_{in}=8-dBm

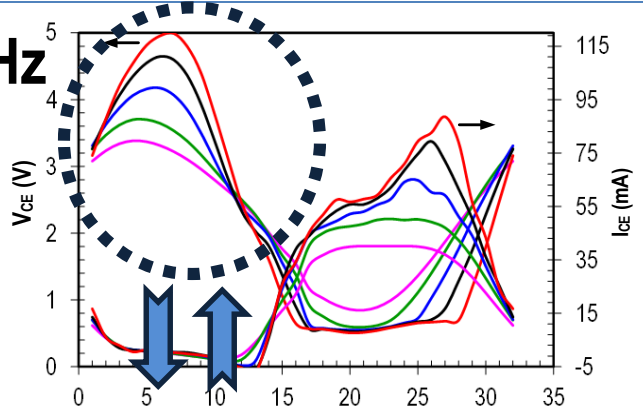
V: Square-wave-like (3rd-harmonic rich)

I: 2nd-harmonic-rich waveform



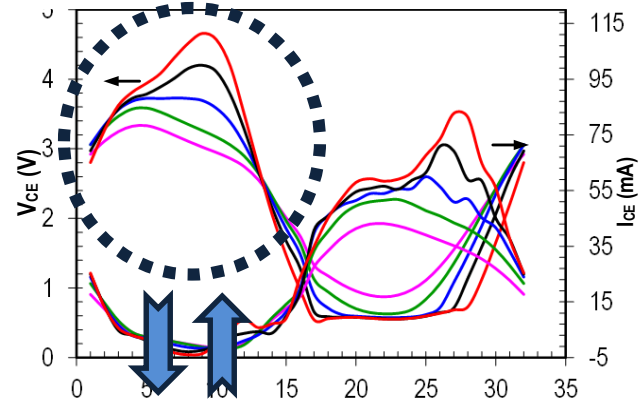
Simulated Collector V-I Waveforms (2)

Class-F⁻¹ @27-GHz

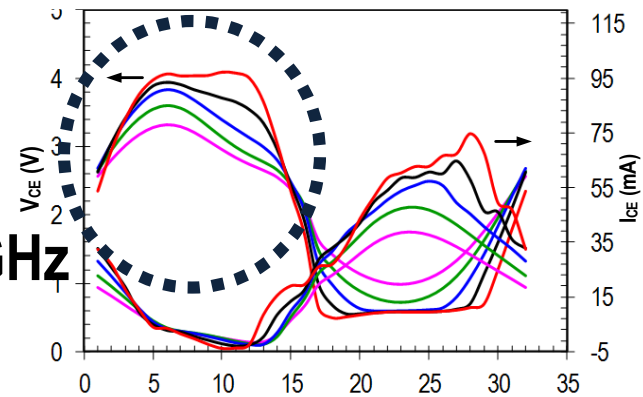


Transition mode @29-GHz

- Transitional ambivalent voltage waveforms between Class-F⁻¹ & Class-F.
- Still can maintain a high-efficiency (similar to “continuous Class-F”).

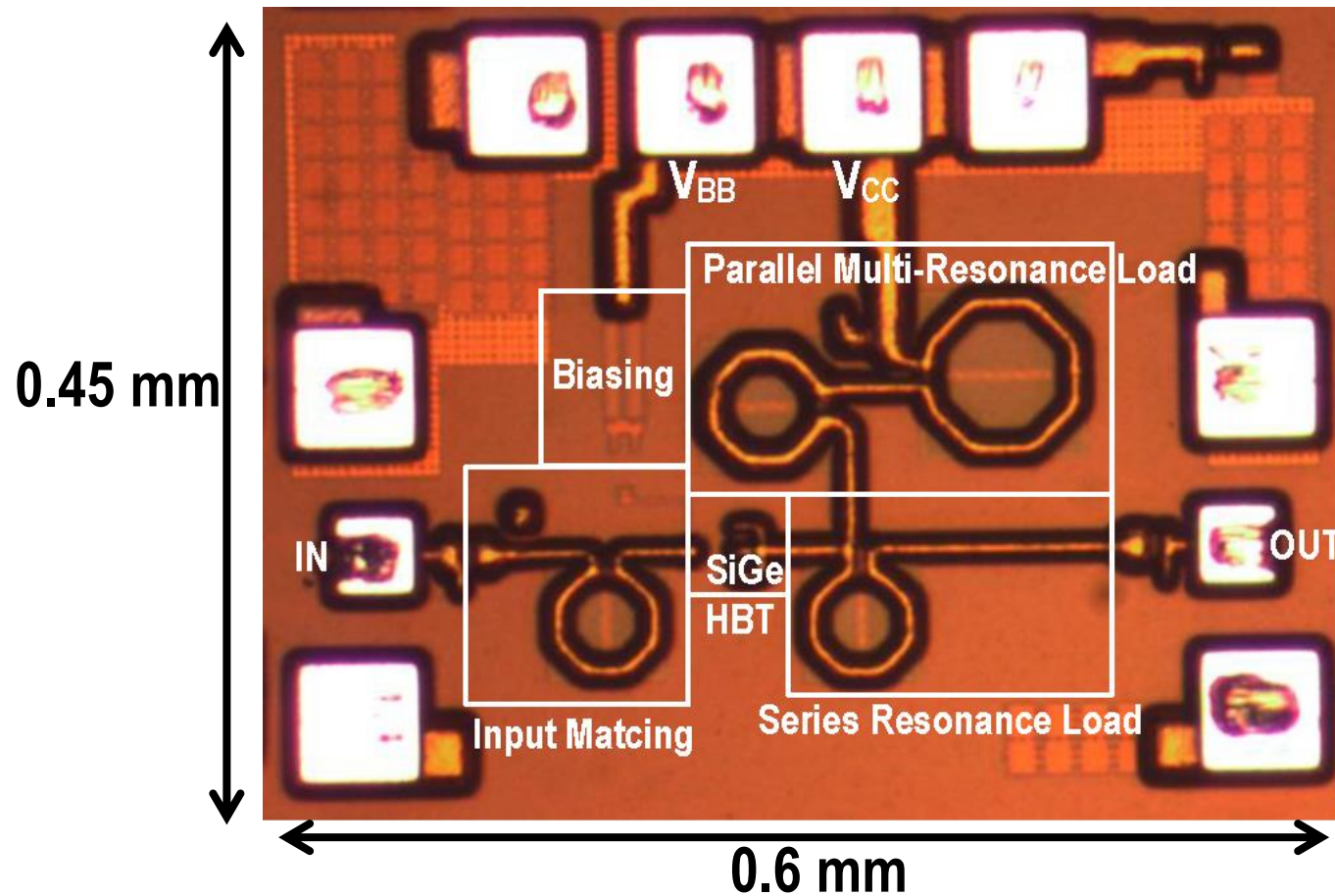


Class-F @31-GHz



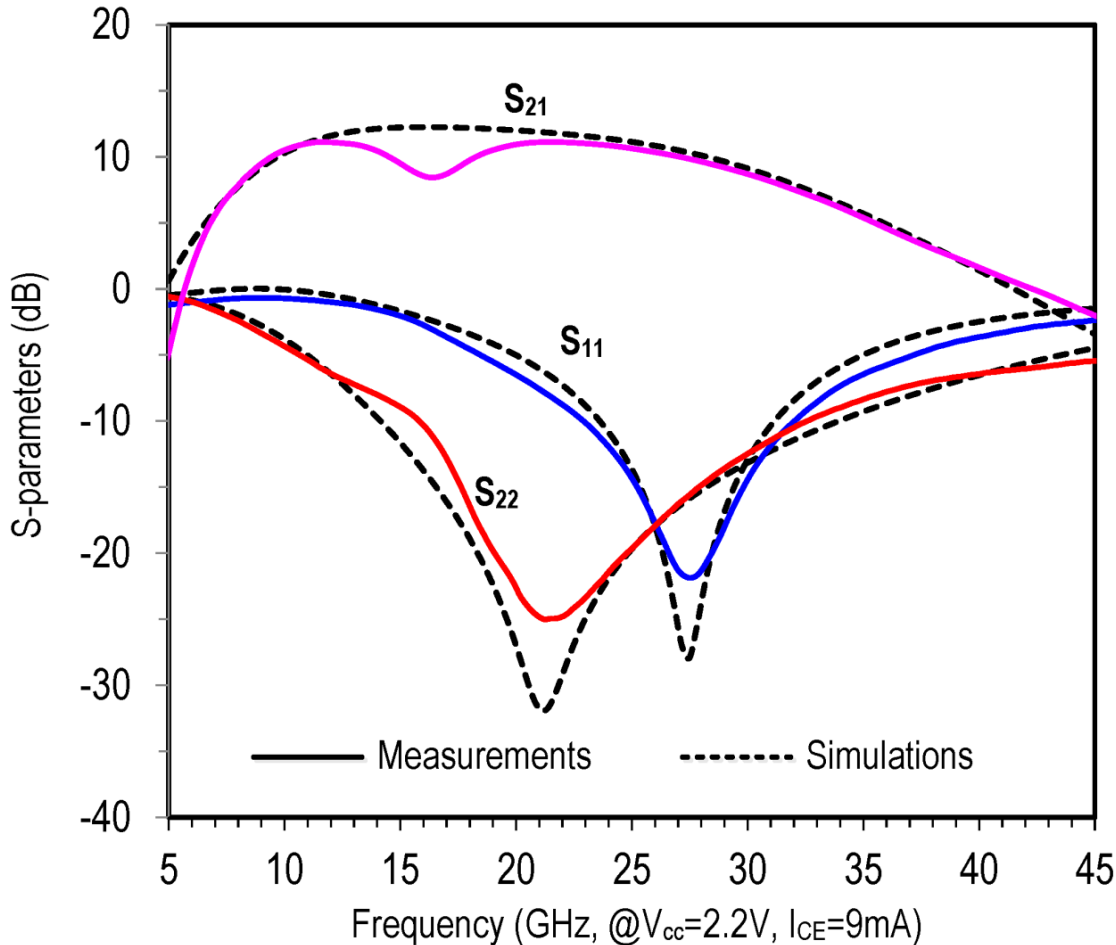
14.4: A Class-F⁻¹/F 24-to-31 GHz Power Amplifier with 40.7% PAE, 15dBm OP_{1dB}, and 50mW P_{sat} in 0.13μm SiGe BiCMOS

Chip Photograph

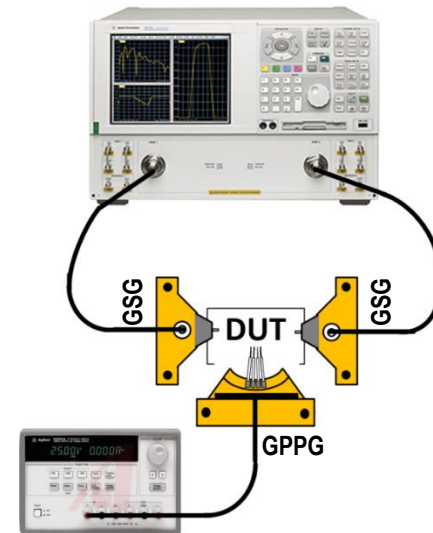


- IBM 8HP SiGe BiCMOS ($f_T=180$ GHz, $f_{max}=200$ GHz)
- Chip area: 0.6×0.45 mm² (w/i pads), 0.48×0.3 mm² (w/o pads)

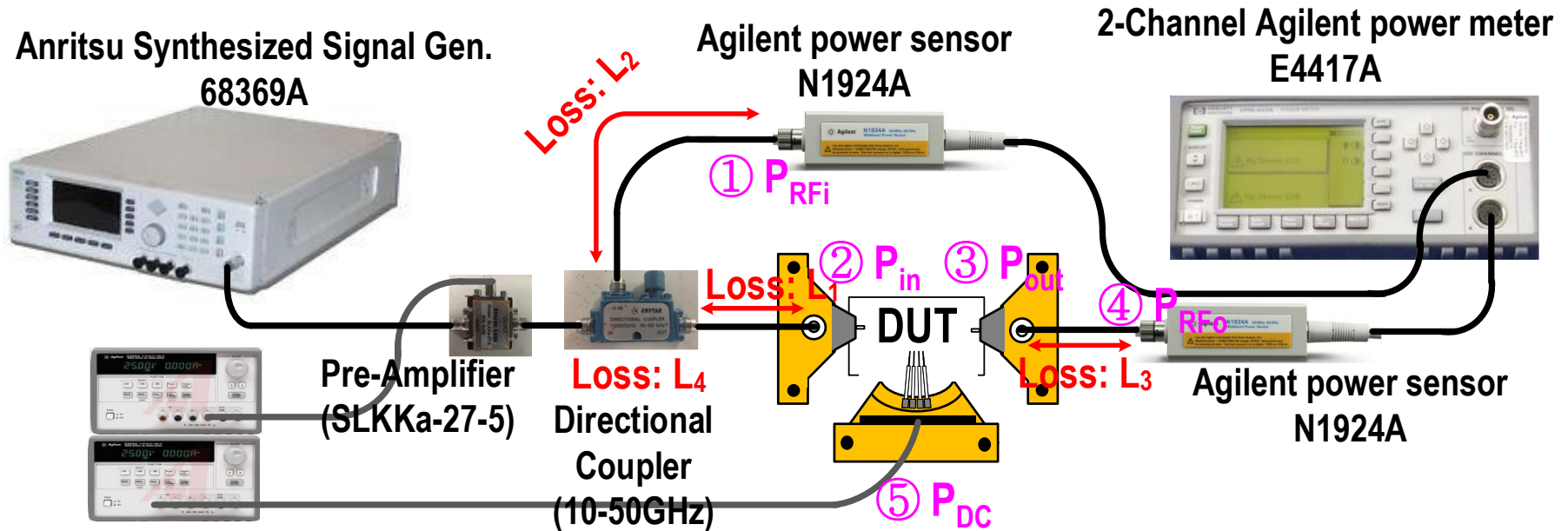
Small-Signal S-Parameters



- SOLT calibration
- Class-AB biasing
($V_{CC}=2.2$, $I_{CE}=9mA$)
- $S_{21} = 9-10.8$ dB : 24~31 GHz
- $S_{11} < -10$ dB : 22.5~32 GHz
- $S_{22} < -10$ dB : 15~33 GHz
- K-factor > 1



Large-Signal Measurement Setup

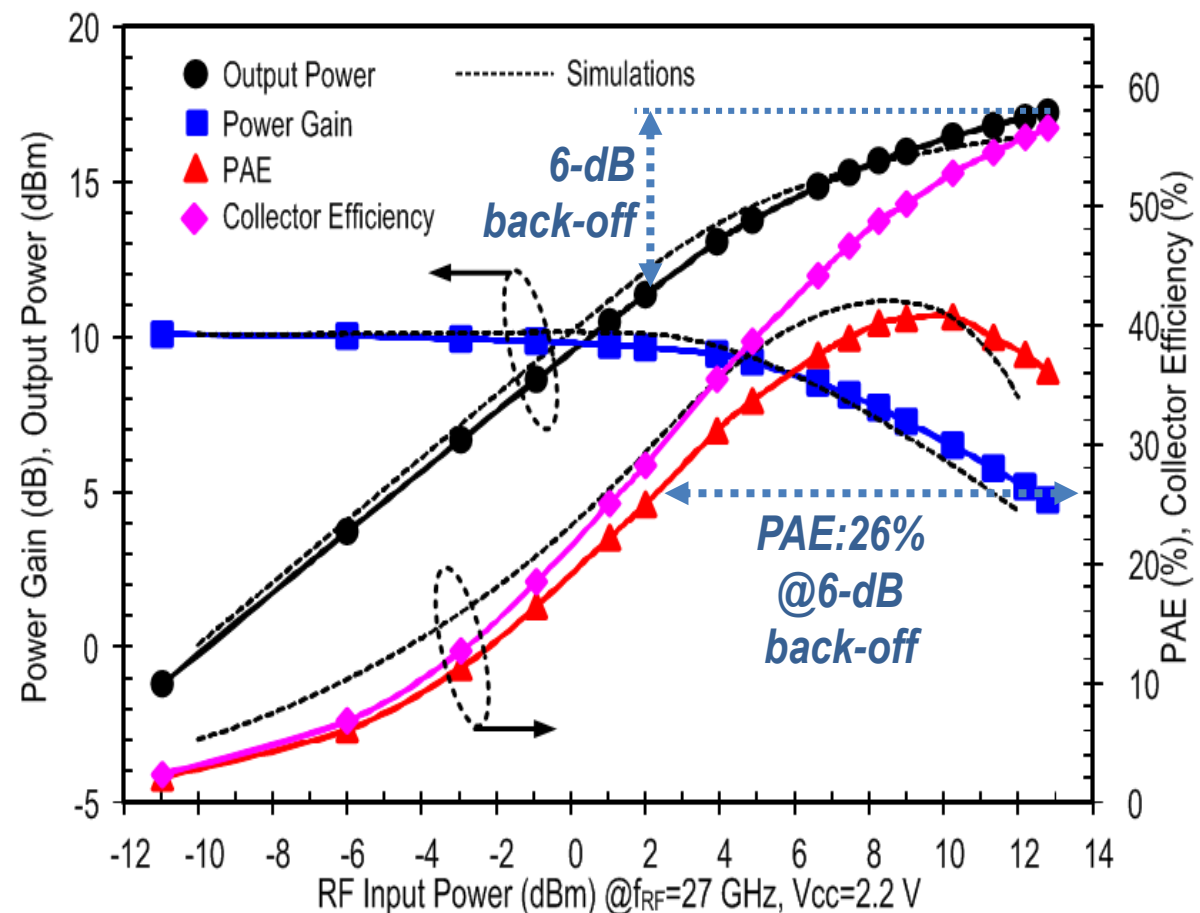


Power Calibration

- L_1, L_2 & L_3 : cable losses, L_4 : coupler loss (typ. 10 dB @24-31 GHz)
- $P_{in} = P_{RFi} - L_1 + L_2 + L_4$ (dB)
- $P_{out} = P_{RFo} + L_3$ (dB)

$$PAE = (P_{out} - P_{in}) / P_{DC}$$

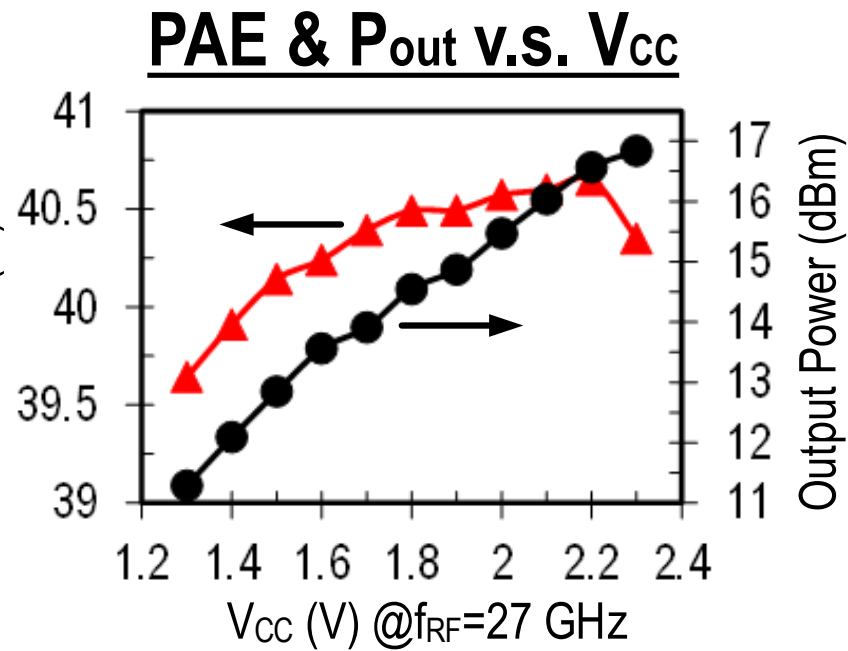
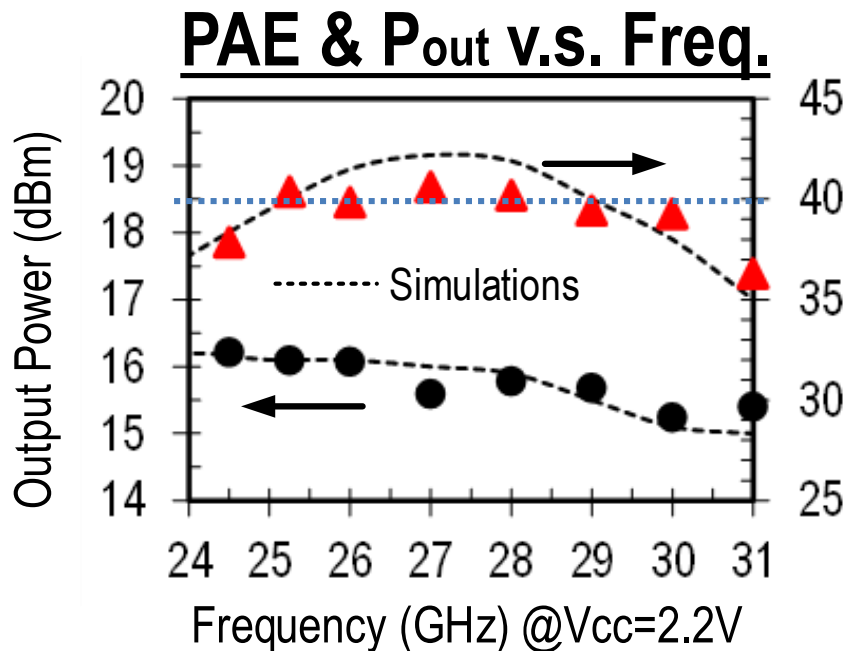
Large-Signal Performance (1)



Measurement @27 GHz

- Class-AB biasing
($V_{CC}=2.2$, $I_{CE}=9$ mA)
- Peak PAE: 40.7%
(Drain η : 52.7%)
- P_{sat} : 17.1 dBm (50 mW)
- OP_{-1dB} : 15 dBm

Large-Signal Performance (2)



- PAE: 39.3-40.7% @ 25-30 GHz
- PAE > 36% @ 24-31 GHz

Note: due to mode-transition, the PA can maintain ~40% PAE over 25-30 GHz.

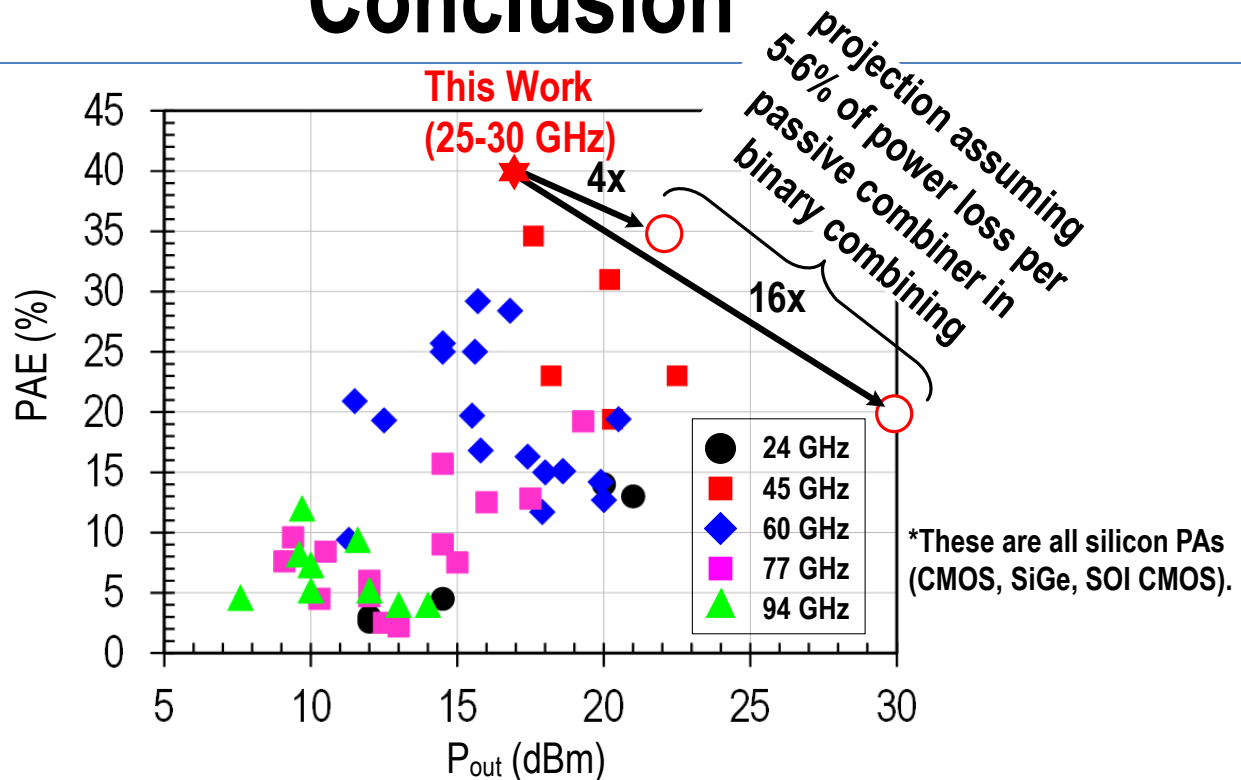
- PAE: 39.6-40.7% @ V_{CC}=1.3-2.3 V

Note: it can maintain ~40% PAE over 1-V V_{CC} variations with ~6-dB P_{out} variations.

Performance Summary & Comparison

Authors	Freq.(GHz)	PAE (%)	P _{sat} (dBm)	OP _{-1dB} (dBm)	Gain (dB)	Size (mm ²)	Supply(V)	Process
This Work	25-30	39.3-40.7	17.1	15	10.3	0.27(0.14*) * w/o pad	2.2	0.13μm SiGe
	24-31	36.3-40.7						
JSSC 2005 A. Komijani, <i>et al.</i>	24	6.5	14.5	11	7	1.26	2.8	0.18μm CMOS
RFIC 2007 M. Chang, <i>et al.</i>	33	11.2	17	15.5	13	1.83	1.4	0.13μm SiGe
JSSC 2005 T.S.D. Cheung, <i>et al.</i>	22 24	19.7 13	20-23	NA	15-19	6	1.8	0.2μm SiGe
RFIC 2005 N. Kinayman, <i>et al.</i>	24	2.9	12	11	18	1.1	5	0.5μm SiGe
T-MTT 2012 N. Kalantari, <i>et al.</i>	38	20	23	NA	18.7	1.04	3	0.12μm SiGe
CICC 2012 A. Chakrabarti, <i>et al.</i>	47	34.6	17.6	NA	13	0.12	2.5	45nm SOI CMOS
CICC 2012 K. Datta, <i>et al.</i>	45	31.5	20.2	NA	10.5	1.3	2.4	0.13μm SiGe
T-MTT 2012 P.-C. Huang, <i>et al.</i>	24-26	40	23.5	22	9	1.5	4	GaAs HEMT
RFIC 2013 N. Kinayman, <i>et al.</i>	26.4	38	25.3	NA	10.3	25	5	GaAs HEMT
MTTs 2012 C.F. Campbell, <i>et al.</i>	29	30	37	NA	25	4.8	20	GaN HEMT

Conclusion



- First successful silicon PA in Class-F⁻¹ and Class-F at mm-wave with a record ~40% peak PAE at 25-30 GHz.
- First successful realization of a mode-transition mm-wave PA to achieve a high PAE over a wideband: 24-31 GHz (25.5% fractional BW) with PAE > 36%.
- A linear mode (Class-AB) PAE with 6-dB back-off is ~26%, still comparable to peak PAE of state-of-the-art silicon PAs.
- With 16x power combining, potentially it can achieve > 20% PAE with Watt-level P_{out} .

Acknowledgements

- DARPA program, *Silicon Based Phased Array Tiles for Multifunctional RF Sensors*, under a subcontract from University of California San Diego (UCSD).
- Prof. G. M. Rebeiz (UCSD) for financial and measurement support.
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